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Design methods and apparatuses of photodiodes with adaptive structures to achieve smooth and wavelength-selective photo-responses

BACKGROUND OF THE INVENTION

1. Field of the invention

[0001] This invention relates to adaptive photodiode structures, of which design methods and apparatuses aiming at smoothing the photo-response and making the photo-response having a peak value at a specific wavelength, ~~that are realized~~ by the photodiodes with color-selective mechanisms and under the condition of without the use of extra color filters.

2. Description of the prior art

[0002] As ~~the progress of the photo-electronic technology~~ progresses and the ~~development of the internet~~ develops, ~~the products of imaging applications~~ imaging application products are welcome in the market where the image sensors are ~~the devices of capturing~~ utilized to capture the images, such as with the digital camera, scanner, PC camera, and video camera. It is obvious that the image sensors play an important role in modern lives. However, during the ~~manufacture process of~~

the image sensor manufacturing process, it is only possible for us to fabricate the photodiodes with that sensing sense different colors, such as red, green and blue, only by means of utilizing color filters. Since each photodiode only senses a specific color, ~~the~~ a back-end image processing mechanism is used to restore the original color image. ~~However, on one hand the~~ The existence of color filters causes ~~the~~ a decrease of the photo-responses of the photodiodes ~~whereas on the other hand and~~ and it also makes the fabrication process more complex and thus increases the fabrication cost.

[0003] The image sensor could be subdivided into two parts: ~~of the front-end~~ photodiode array and the back-end signal processing circuit, where its architecture could be illustrated, as shown in Fig. 1. Each photodiode is connected to an amplifier, which transfers the captured image signal into the electrical signal. Additionally, the overall photodiode array is arranged by using the red, green and blue photodiodes as shown in ~~the~~ Fig. 1 according to the perceptual principle of human vision. As for the signal processing part, it comprises the decoder, timing-control unit, compensating and synthesizing circuit, etc. From ~~the~~ Fig. 1, it ~~could~~ can be seen that the photodiode plays the transformation from photon to electron, and this invention proceeds innovative design aiming at the photodiodes of the

image sensor.

[0004] The ~~A~~ conventional color photodiode is shown in Fig. 2, ~~which is to add~~ whereby a layer of material with a light-filtration effect ~~upon~~ is added to each photodiode ~~as well as the general standard process to yield each color~~. Such fabrication method ~~makes the~~ creates a photodiode having a with a large response toward a specific wavelength and a lessening lesser the responses response of to the unwanted wavelengths, ~~of which operation is to filter~~ thereby filtering out the unwanted wavelengths of the incident light. Let's take the common-used red, green and blue filters as an example, their color photodiodes showing the photo-responses as shown in Fig. 3. However, such fabrication method has the following drawbacks.

[0005] (1) The fabrication process requires the extra steps ~~in addition to the original standard process~~. That is to say, ~~the extra several~~ additional masks are required when the color filters are added on top of the common-used standard fabrication process, which increase the manufacture cost.

[0006] (2) Most of the incident light is absorbed and reflected during the process of passing through the color filter, which decreases the photo-response of the photodiode as well as makes inferior influence upon the characteristics of the

devices. Hence, one extra process of micro lens is included for the commonly-used color filter to focus incident light with the purpose of increasing the induced current.

[0007] (3) In order to meet the requirement of sensing different colors, the process must provide different color filters which increases the degree of difficulty on the fabrication process. ~~To integrated with the micro lens, the fabrication process should be modified in extra~~ In order to integrate the micro lens with the fabrication process, the fabrication process must be additionally modified when there is a larger degree of alteration for the sensing area of a photodiode that yields a better response under a specific curvature radius of the lens.

[0008] In fact, despite of the above-mentioned three drawbacks, since each photo-sensitive material of a photodiode has non-uniform responses toward different wavelengths of incident light, the color filter should be designed by taking into consideration the photo-sensitive characteristics of the material itself. On the other hand, the back-end color compensation circuit is developed ~~with considering the~~ based on the characteristics of the color filter, mainly the transmission rate of incidence light, which makes the overall design more complicated.

[0009] From the above-mentioned, it is understood that there still are many drawbacks in the conventional fabrication process which needs to be improved.

The inventors of this invention, due to understanding each drawback derived from the conventional color photodiodes, tried to improve it by studying hard for many years, and finally they successfully accomplished the research of the photodiodes with adaptive structures to achieve smooth and wavelength-selective photo-responses of this invention.

Field of the invention:

[0010] To sum up, the above-mentioned describes some drawbacks of the currently-used color image sensors, ~~which are required to be improved where this~~ This invention provides the method and apparatus of improving them by the following ways.

[0011] (1) ~~To make the compensation design toward each photodiode to have the smooth photo-response in the visible wavelength by adapting the size of the photodiode area and the gain of the photodiode amplifier, the design of the back-end color compensation circuit could be simplified.~~ Several different gains of photo signals are accumulatively added so as to improve the uniformity of photo-responses (see Fig.16). In such a way the complexity of the color processing circuit is reduced. There are two methods for obtaining different photo signal

gains, one is to adjust the size of the photodiode area; the other is to vary the gain of the back-end amplifier circuit. With the two methods the different photo signal gains can be obtained (see Fig. 17). After that by accumulatively adding the photo signals of different gains thereby obtaining desired photo signals (see Fig.16).

[0012] ~~(2) The design method of the optimized photodiodes is developed by effectively utilizing some physical characteristics of the process parameters comprising how to acquire the maximum photo-response at a specific wavelength.~~

[0013] ~~(3) In prospect of the process technology, this invention provides the way of utilizing the multiple PN junctions to design the adaptive photodiodes. By utilizing such approach, the different photo-responses within an adaptive photodiode could be obtained when this photodiode is implemented by an adequate layout.~~ This invention provides a way of utilizing fabrication process of multiple PN junctions so as to realize design of adaptive photodiode for photo-response(see Fig.19), and a switch is equipped on each layer to serve for selecting PN junctions according to its different switching states (see Fig.23) that generate different photo-responses. In this manner the color filter function is not necessary for realizing multi-color pixels.

[0014] The above-mentioned three ways improve the drawbacks mentioned

before. The first one improves the issue of non-uniform photo-responses at different wavelengths, ~~that~~ That can be beneficial to the simplification of the back-end color compensation circuit, ~~whereas the~~ The second and third ~~ones~~ ways mentioned above ~~are to~~ overcome the drawbacks ~~brought~~ created by the color filters. In the present invention the color filter function ~~of which function~~ is replaced by the adaptive photodiode with a wavelength-selective photo-response.

Detailed description of this invention:

[0015] ~~First it is illustrated that this invention derives the photodiode model as well as explores the influence of physical parameters of the photodiode toward the photo-response. Next, to design the photodiode by utilizing the phenomena discovered from the physical parameters, the color photodiodes can be accomplished without color filters under the standard fabrication process. Finally, the photodiodes of this invention are realized through several chips fabricated by TSMC (Taiwan Semiconductor Manufactory Company).~~ The present inventor is the harbinger who discloses the idea of accumulatively adding photo signals including different sizes of the photodiode area and the different gains of the back-end amplifiers of the photo pixels so as to perform a compensated design for

multicolor pixels of different responses. In this way the layout of the backend color compensating circuits can be simplified. For the fabrication technique, the present invention sets forth a new idea employing multilayered PN junctions to form adaptive color photo pixels. With such a fabrication process, only by skillfully arranging chip layout, a variety of photo responses can be achieved which is able to be plotted in a form of a continuous curve on the graph. In the above two methods, the first one achieves the purpose of simplifying the back-end color compensating circuit design by improving non-uniform responses of individual frequency bands; and the second one realizes creating the color photo pixels without the need of a color filter.

1. Introduction to the basic principle of this invention:

[0016] Before presenting the design methods and apparatuses of this invention, ~~first it is simply illustrated toward~~ the basic principle of this invention are described: ; the principle derivation and model simulation of the photo-response of the photodiode.

[0017] ~~The reason why the photo-current is produced comes from generating the electron-hole pair excited by the incident light,~~ Photo-current is produced when incident light excites an electron-hole pair and next then separating separates the

electron-hole pair by using the voltage potential on both ends of the N-type and P-type semiconductors to yield the photo-current. The whole process is shown in Fig.

4. Here, there are two main sources for the production of the photo-currents: the first one comes from the diffusion current caused by the uniform distribution of the carrier concentration beyond the depletion region, and the second one comes from the electric field within the depletion region where the electric field separates the electron-hole pairs produced by induction to generate the drift current.

[0018] Next the photon flux, which is defined to be the number of the electron-hole pairs excited within the unit area under a specific incident light, is represented by φ_0 in the following equation,

$$\varphi_0 = \frac{P_{in} (1 - R(\lambda))}{Ah \nu} \dots\dots\dots(2.1)$$

where P_{in} is the energy of the incident light, $R(\lambda)$ represents the reflection rate of the incident light that is the a function of wavelength, A is the light shading area, h represents the Planck's constant, and ν represents the frequency of the incident light which could can be obtained by utilizing taking the velocity of light divided by its wavelength. The subscript symbol of φ_0 in the Eq.(2.1) represents the relationship between the photon flux with to the distance from the lighted surface,

which is illustrated in Fig. 5. If ϕ_0 is the photon flux on the lighted surface, then the photon flux will be decayed exponentially along with the distance from the lighted surface. If ϕ_x represents the photon flux on distance x from the lighted surface, then ϕ_x could be represented as the following equation.

$$\phi_x = \phi_0 e^{-\alpha x} \dots\dots\dots(2.2)$$

[0019] The absorption coefficient α is an important parameter which is related to the a material. Since each material has a different energy band and the energy carried by the photons is Inversely proportional to the wavelength of these photons, the energy carried by the photons should be larger than the energy band of the material such that it could be absorbed by the material to yield the electron-hole pairs. The probability of the photons being aborted by the material conforms with the principles of the Gaussian distribution. If the energy carried by the incident photons is larger, then the chance of the photons carrying high energy being absorbed at the position near the surface is larger. Otherwise, if it is smaller, the chance is also smaller, so that it will be absorbed ~~on the~~ at a deeper position ~~which is far further~~ away from the surface of the material, to yield the electron-hole pairs. Because ~~the energy of the photons~~ photon energy is inversely proportional to their wavelength, ~~the longer the wavelength of the incident light is,~~ the deeper the

position the incident light is absorbed at. Additionally Conversely, the shorter the wavelength is, the shallower the absorption position it is absorbed at. Hence, another physical parameter should be mentioned here: the absorption length position, by definition, ~~it being~~ is the reversal of the absorption coefficient $1/\alpha$, which means that at the a fixed-wavelength incident light, its energy is decayed to $1/e$ of the ~~original one~~ initial energy after it passes through the distance of $1/\alpha$ away from the lighted surface. The absorption length depth versus the wavelength of the incident light λ is depicted in Fig. 6 a and b. From Fig. 6 a and b, it is clearly ~~discovered~~ shown that the longer the wavelength of the incident light is, the longer deeper its absorption length depth is. In other words, the incident light with a longer wavelength penetrates to a deeper position before absorption. According to ~~the an~~ experimental result, the relationship between the absorption coefficient α and the wavelength of the incident light λ , ~~taking the~~ using silicon as the material, is formulated as below.

$$\log_{10} \alpha = 13.2131 - 36.7985\lambda + 48.1893\lambda^2 - 22.7562\lambda^3 \dots\dots\dots (2.3)$$

[0020] According to the physical characteristics of the photodiode, the simulation of the photo-response is carried out by the following equations:

- (1) the thermal equilibrium equation of minor carriers,

- (2) the density equation of the photo current on both sides of the lighted material,
- (3) the continuity of minor carrier density and current density at the homogeneous materials, and
- (4) the concentration equilibrium equations on the boundary condition of the depletion region between the heterogeneous materials.

Fig. 7 illustrates the a photodiode with the Nwell-Pepi-Psubstrate junction structure by using the 1P3M 0.5um CMOS epitaxial wafer process provided by the TSMC, whereas Fig. 8 shows the comparison between the simulation and the measurement results toward said photodiode. ~~From results of Fig. 8, the derived model is very promising to estimate the behavior of the photo-response of the photodiode.~~ The model results of Fig. 8 show that it is possible to estimate photodiode photo-response behavior.

2. The derivation and analysis of the simple model of this invention:

[0021] After simulation and derivation of the photo-response model of the photodiode, the impact of each parameter toward the photo-response should be understood. After understanding the impact of these related parameters toward the photo-response, the required design task could be preceded by utilizing such

characteristics of which two main parameters are ion implantation concentration and ion implantation depth.

[0022] The concentration of ion implantation affects the magnitude of the photo current since the photodiode is operated under the reverse bias voltage. The minor carriers are attracted by the electric field inside the depletion region, then they pass through the depletion region quickly, and thus they ~~could~~ form the photo currents efficiently. Hence, ~~the~~ if there is a larger the ion implantation concentration of ion-implantation is, the more chance the recombination of minor carriers on the path of drifting onto the depletion region has so that the number of minor carriers which forms the photo current relatively reduces then there is a greater chance for minor carrier recombination on the drift path into the depletion region, thereby relatively reducing the number of minor carriers that form the photo current. The whole process is depicted in Fig. 9, where the black spots in the upper part of the figure is are the major carriers, ~~which could be viewed as the~~ (concentration of Ion Implantation,) and the white spots that represent the minor carriers, ~~whereas in~~ In the lower part the white spots ~~could be viewed as~~ are the concentration of Ion implantation, and the black spots represent the minor carrier. From Fig. 9, the number of ions being doped impacts upon the number of minor carriers reaching to

the boundary edges of the depletion region. Fig. 10 illustrates the relationship between the ion implantation concentration and the mean lifetime of minor carriers. From Fig. 10, it ~~could be clearly~~ can be seen that the larger the concentration of ions being doped is, the shorter the mean lifetime of the minor carrier ~~is~~, and thus, the smaller the induced photo-currents ~~are~~.

[0023] The depth of ion implantation affects how the photodiode ~~to absorb~~ the wavelengths of incident light. Referring to the above-mentioned absorption length and Fig. 6, it ~~could~~ can be seen clearly that the light with a longer wavelength penetrates to the deeper junction, so the incident light with a longer wavelength can excite electron-hole pairs at the deeper region. However, to become photo-currents, the electron-hole pairs should reach to the boundary edges of the depletion region successfully such that they would be absorbed and transformed to the photo-currents. In other words, the photodiode has a greater response ~~toward the~~ with respect to incident light with a longer wavelength at the deeper region whereas for the shallower region it has a better response ~~toward~~ with respect to the incident light with a shorter wavelength.

[0024] Fig. 11 shows the simulation results of the currents contributed by the three regions of the photodiode ~~as~~ shown in Fig. 7. The depth of the junction

formed by the Nwell region is ~~shorter~~ more shallow, so it has a larger response ~~toward a~~ with respect to shorter wavelength, wherein the peak value of the photo-response occurs at a shorter wavelength. The depth of the junction formed by the Psubstrate region is deeper, so the Psubstrate region has a better response toward the incident light with a longer wavelength, so the peak value appears in a longer wavelength. As for the magnitude of the photo-currents, since the doping concentration in the Psubstrate region is lower than that in the Nwell region, a larger amount of photo-currents from the Psubstrate region are induced. ~~As well in~~ addition to as revealing how the ion implantation concentration affects the magnitude of the photo currents, another phenomena could be observed clearly: the current contributed by the Psubstrate region is obviously larger than those contributed by the other two regions. The reason is ~~that the~~ due to the depth in the Psubstrate region ~~is too long~~. Due to a ~~long~~ greater depth, a large amount of the photons are absorbed in the Psubstrate region, which makes the photo-response of the Psubstrate region being almost equal to the overall photo-response from the three regions. As for the magnitude of the current in the depletion region, it is determined by the width of the depletion region. In general, ~~the width of the depletion region is within several micron meters, so there is little for the drift current~~

generated from the depletion region since the width of the depletion region is only several micron meters, the amount of the drift current produced is very small.

[0025] Two ideas ~~appear from my thought here~~ emerge from the above mentioned discussion. The first one is the method to compensate non-uniform distribution of the photo-responses of the photodiode at different wavelengths. When the photo-responses that used to have low values at some wavelengths are efficiently increased, and these photo-responses at different wavelengths are integrated, a curve with uniform distribution of the photo-responses at different wavelengths can be obtained. This method can be useful to simplify the design of the color compensation circuit. From this we also conclude some design principles of the manufacture process to achieve the optimized photodiode with uniform distribution of the photo-responses at different wavelengths. The second idea comes from the requirement of removing the color filters. From the previous simulation results, it could be seen that the overall photo-response is obtained by integrating the partial photo-responses at different wavelengths. Hence if we could find a method to independently obtain several partial photo-response, these photo-responses in one photodiode could individually show up under a control mechanism without using color filters.

BRIEF DESCRIPTION OF THE DRAWINGS

[0026] The drawings disclose an illustrative embodiment of the present invention which serves to exemplify the various advantages and objects hereof, and are as follows:

[0027] Fig. 1 is ~~the~~ a framework drawing of the conventional digital image sensor where the photodiode array using active pixel sensor cells in the CMOS process is taken as an example, and the R, G and B color array is arranged according to ~~the~~ human vision.

[0028] Fig. 2 is ~~the~~ an illustrated drawing of the cross section of the conventional color photodiode where the micro-lens in the upper part is added to enhance the photo-response.

[0029] Fig. 3 is the photo-responses of the red, green and blue color photodiodes, where the peak values of the photo-responses in these three photodiodes appear near red (650 nm), green (550 nm) and blue (450nm). The most upper curve in the figure is the photo-response of the original photodiode without using a color filter.

[0030] Fig. 4 is the generation process of the photo-currents where the shaded

region is the depletion region yielding the drift current, and the other regions generate the diffusion currents.

[0031] Fig. 5 is the relationship between the photon flux and the distance from the lighted surface showing exponent decay.

[0032] Figs. 6 (a) and (b) show is the relationship between the absorption lengths and the wavelengths λ , where Fig. 6(a) is the absorption lengths at the wavelength from 400nm to 1000nm and Fig. 6(b) is the scale-up view for the absorption lengths at short wavelengths.

[0033] Fig. 7 is the Nwell-Pepi-Psubstrate junction of the photodiode in TSMC 1P3M 0.5um CMOS epitaxial process.

[0034] Fig. 8 is the simulation and measurement results of the photodiode in Fig. 7.

[0035] Fig. 9 is the relationship between the concentration of ion implantation and the number of minor carriers where the white spots at the upper part represent the minor carriers and at the lower part the minor carriers are black spots.

[0036] Fig. 10 is the relationship between the concentration of Ion implantation and the mean lifetime of the minor carriers where the horizontal coordinate unit represents the power with a base of 10, and it could be found that the larger the

concentration of ion implantation, the shorter the mean lifetime of the minor carriers.

[0037] Fig. 11 is the simulated photo-responses in three regions of the photodiode in Fig. 7.

[0038] Figs. 12 (a), (b) and (c) show is the measured results of the photodiodes utilizing the TSMC 1P3M 0.5um CMOS expitxial wafer process where the lines with black spots are the photo-responses of the photodiodes without color filters, and the lines with white spots are the photo-responses of the photodiodes with color filters. Fig. 12(a) is the photo-responses of the photodiodes with and without the red filters, Fig 12(b) is the photo-responses of the photodiodes with and without the green filters and Fig 12(b) (c) is the photo-responses of the photodiodes with and without the blue filters.

[0039] Fig. 13 is the measured results of the color photodiodes.

[0040] Fig. 14 is the uniform distribution of the photo-response.

[0041] Fig. 15 is the integrated photo-responses of the photodiodes to approximate the photo-response of Fig. 14.

[0042] Fig. 16 is the photo-responses of the color photodiodes being linearly added where the gains of A1, A2, ..., and An could be accomplished by adapting the areas of the photodiodes or the gains of the amplifier circuits.

[0043] Figs. 17(a), (b) and (c) are ~~is the~~ block diagrams of adapting the areas of the photodiodes and the gains of the amplifier circuits where Fig. 17(a) shows the different photo sensing areas, Fig 17(b) shows the different gains of the back-end amplifier circuits and Fig. 17(c) shows the adequate areas and gains being integrated to achieve the smooth response.

[0044] Fig. 18 is the structures of the photodiodes in TSMC 1P3M 0.5um and TSMC 1P3M 0.6um process.

[0045] Figs. 19(a) and (b) ~~is show~~ the structures of the photodiodes with multiple PN junctions of this invention where the lighted surfaces in Fig. 19(a) and Fig. 19(b) are N-type and P-type semiconductors, respectively.

[0046] Fig. 20 is the photodiode with two PN junctions which are formed by the Pdiffusion-Nwell and Nwell-Psubstrate where the photodiode with said structure can be implemented by TSMC 1P3M 0.6um process and TSMC 1P4M 0.35um process.

[0047] Fig. 21 is the simulation result of the photodiode in Fig. 20 where the lines with the black and white spots are the photo-currents generated by the photodiode in junctions of Pdiffusion-Nwell and Nwell-Psubstrate, respectively.

[0048] Fig. 22 is the photodiode with showing a shorting of a PN junction, which

causes the electron-hole pairs being recombined again and again to make the junction current become zero such that these exist two kinds of shorting connections in this photodiode to yield two photo-responses as shown in Fig. 21.

In other words, shorting, under general operation, means that the P terminal serves as the output terminal while the N terminal is grounded. In the present invention, "short" means to short-circuit the P and N terminals by connecting them together as to recombine the electrons and holes produced on the PN junction over and over.

[0049] Fig. 23 is the color photodiode with an adaptive structure provided by this invention where ~~SW1, SW2, ... and SWn~~ Switch1, Switch2, ..., and Switch are the switches which are used to generate different photo-responses.

[0050] Fig. 24 is the simulation results of the photo-responses of the photodiode with three PN junctions where the photo-responses generated by the first through the third PN junctions are shown from left to right.

[0051] Figs. 25 (a) and (b) is the photo-responses of the Pwell-Pepi-Psubstrate photodiode fabricated by the TSMC 1P3M 0.5um process under various reverse bias voltages where Fig. 25(b) is the scale-up view of the partial portion of the photo-response in Fig. 25(a), the highest curve being generated at the reverse bias voltage of 5V, the middle at 3V and the lowest at 0V.

[0052] Fig. 26 is the photo-responses of the depletion region of the Nwell-Pepi-Psubstrate photodiode fabricated by the TSMC 1P3M 0.5um process under various reverse bias voltages where the highest curve is generated at the reverse bias voltage of 5V, the middle at 3V and the lowest at 0V.

[0053] Fig. 27 is the photo-responses of the Nwell-Pepi-Psubstrate photodiode fabricated by the TSMC 1P3M 0.5um process under various reverse bias voltages; from the result it could be found that, when the reverse bias voltage changed from 0V to 5V, the curves of photo-responses almost are the same.

[0054] Figs. 28 (a), (b) and (c) is are the photo-responses produced by summing photo-responses of two photodiodes at different photo-sensing areas where Figs. 28(a), 28(b) and 28(c) are the summed photo-responses of two photodiodes fabricated by the TSMC 1P4M 0.35um process, TSMC 1P3M 0.5um process and TSMC 1P3M 0.6um process, respectively.

[0055] Figs. 29(a), (b) and (c) is are the photo-responses produced by utilizing different shorting connections of the photodiodes where Figs. 29(a), 29(b) and 29(c) are the photo-responses of the photodiodes fabricated by the TSMC 1P4M 0.35um process, TSMC 1P3M 0.5um process and TSMC 1P3M 0.6um process, respectively.

[0056] Fig. 30 is the photodiode with three PN junctions.

[0057] Figs. 31(a), (b) and (c) ~~is~~ are the connection topologies of the photodiode in Fig. 30 generating red, green and blue where Figs. 31(a), 31(b) and 31(c) are the connection topologies for generating blue, green and red, respectively.

[0058] Fig. 32 is the simulated photo-responses of the photodiode in Fig. 30 with the connection topologies ~~in~~ of Fig. 31.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENT

[0059] The design methods and apparatuses of photodiodes with adaptive structures to achieve smooth or wavelength-selective responses of this invention are explored based on the following concepts.

1. Make the photo-response distribution more uniform ~~distribution~~ by utilizing ~~the way of~~ signal summation, which is beneficial to simplify the design of the color filters and back-end color compensation circuits.
2. Disclose the optimized parameter values for the semiconductor process to achieve the uniform distribution of the photo-response and to obtain the maximum photo-response as well as the peak value at a specific wavelengths.
3. Design the photodiode with multiple PN junctions to achieve multiple

wavelength-selective responses, and this photodiode after an adequate layout design does not need the whereby the resultant photodiode does not require the addition of color filters to sense different colors.

[0060] Accordingly, it will be explained in detail with the following paragraphs aiming aimed at the above-mentioned issues:

1. Method of linear summation

[0061] The reason why we propose this design method is to obtain the a photo-response with a mere smoother curve. Figs. 12(a) and (b) shows the measured results of the two different photodiodes utilizing TSMC 1P3M 0.5um CMOS epitaxial wafer process. Fig. 13 is the measured results of the photodiodes with red, green and blue filters. From Fig. 13 it is obviously seen that the magnitude of the photo-responses vary at various wavelength segments. Because of such reason, when we design the color image sensor, we must consider on one hand the impact of the color filter toward with respect to the original photodiode should-be taken into account, and on the other hand, of while designing the back-end color compensation circuit, the photo-responses of the photodiodes with red, green and blue filters should be taken into consideration, which increases the degree of design difficulty. Thus this the present invention design method has been proposed

to achieve the photo-response shown in Fig. 14 that can be formed by the photo-responses of multiple photodiodes, as shown in Fig. 15, with color filters at the same transmission rate.

[0062] The approach of this invention as shown in Fig. 16 is to sum the photo-current signals of the photodiodes with various photo-responses, which means that ~~the several different photo signals~~ performs linear combination or addition by utilizing multiple photodiodes with various photo-responses so that the overall photo-response becomes smooth. Before summation of these photo-current signals, adequate gains should be made toward such photodiodes with various photo-responses. This invention proposes three ways of generating the photo-currents. The first one, as shown in Fig. 17(a), directly changes the area of the lighted region of the photodiode, since the value of the induced photo current signal is proportion to the lighted area. Hence the area alteration could achieve the ~~purpose~~ result of adjusting the photo-response. The second way is illustrated in Fig. 17(b), which is achieved by utilizing the back-end amplification circuits to have different gains, that can result in adjusting the photo-responses. The third, which is the combination of the above-mentioned two ways, obtains the smooth photo-response by adequately determining the lighted areas of the photodiodes and the gains of back-end

amplification circuits.

2. Methods of determining the optimized values of the process parameters

[0063] There are many choices to determine the values of the process parameters for achieving the purpose of the maximum photo-response at a specific wavelength. However, since there still are some certain rules to follow due to the characteristics of these parameters, this invention ~~try to find a set~~ provides a set of optimized process parameters to achieve the required photo-response.

[0064] Before this, reasonable limitation for the ranges of the parameters used in the fabrication process is required. First, the ion doping concentration ranges from 1×10^{14} to $1 \times 10^{20}(\text{cm}^{-3})$, of which the minimum concentration is confined by the process technology which still ~~leaves the space~~ has room for improvement in the future evolution of the process; and the maximum concentration is limited by the physical structure. Let's take the silicon material as an example, its atomic density being $5 \times 10^{22}(\text{cm}^{-3})$, which means that $1 \times 10^{22}(\text{cm}^{-3})$ ionic doping concentration almost reaches its physical limitation. Next, the practical limitation of the thickness of a material layer should be taken into consideration. In general, the minimum thickness would be near $10\mu\text{m}$ so that the layer could withstand the pressure during fabrication. On the other hand, in considering the impact of the absorption

coefficient, the thickness of a material layer could thus be within two to three times ~~that~~ of the absorption length ~~thickness~~. For example, the threshold wavelength of the silicon substrate is about $1\mu\text{m}$. An incident light wavelength beyond such threshold could not emit the electron-hole pairs since its energy is smaller than the energy band of silicon. Hence the absorption length of the incident light with a wavelength of $1\mu\text{m}$ is about $150\mu\text{m}$, and thus the thickness range for investigation is between $0.01\mu\text{m}$ to $500\mu\text{m}$.

[0065] Next, simulations of the photo-diode illustrated in Fig. 4 is performed, where we found that the larger the photo-response is the lower the concentration is. The lower ion doping concentration means the longer lifetime of the minor carriers so that it is preferred to make the concentration of doping as low as possible ~~where so that a~~ the larger photo-response can be obtained. The thickness has to be investigated from two parts: the first one determining the thickness of the lighted layer and the second determining the thickness of the unlighted layer. It was founded that all these peak values appear when the thickness of the lighted layer is close to the width of the depletion region. The reason ~~why makes for~~ such a phenomena could be explained from the carrier absorption rate. The process ~~from that by which~~ the P-type and N-type regions are excited by the incident light in

order to generate the electron-hole pairs ~~to so~~ that the electron-hole pairs are absorbed by the depletion region ~~is to form~~ the photo current. Since the generation rate of carriers has logarithmic decay, only at the edge of the depletion region the generated electron-hole pairs can efficiently yield the photo currents. However, due to a built-in electrical field within the depletion region, the absorption rate of the electron-hole pairs within this region could reach 100%. The electron-hole pairs inside the depletion region could completely form the photo-current. Based on such reasoning, if we could extend the width of the depletion region to the lighted surface, then the electron-hole pairs generated by the lighted layer could be completely absorbed for generating the photo-current.

[0066] The second part is to determine the thickness of the unlighted layer. The ~~more thick the thickness of~~ thicker the unlighted layer is, the higher the photo-response is, which also involves the issue of carrier absorption. What is the difference between the lighted and unlighted layers? At the lighted layer, when the depletion region extends to cover this layer, the usage ratio of the carriers is maximal. However, at the unlighted layer, when its thickness is increased, its absorption rate toward carriers also becomes larger because of more carriers being absorbed. That is to say, on the choice of the thickness of the unlighted layer,

except for the thickness being selected larger than that of the depletion region, the carrier absorption effect is considered so that the thickness of this layer must be widened to achieve a larger photo-response. One point should be mentioned here, and that is the phenomena of the photo-response not obviously increasing after the thickness of the unlighted layer reaches two to three times of the diffusion length. This is because it is affected by the absorption length.

[0067] According to the above-mentioned analyses of the physical phenomena, there are several conclusions summarized below on increasing the photo-response.

- (1) The carriers from the lighted layer are to be absorbed completely, if possible, before reaching the depletion region, so the thickness of the lighted layer is designed, that can be filled by the depletion region.
- (2) As thick as possible for the unlighted layer beyond the depletion region, at least it should be thicker than the thickness of the depletion region to increase the number of carriers being absorbed.
- (3) Decrease the doping concentration if possible.

[0068] Listed below are several main parameters which affect the photo-response, as represented by Eq. (2.4). This equation is the function of the photo-response, where WU represents the depth from the lighted surface to the depletion

region, WD represents the thickness of the unlighted semiconductor material, and n and p represent the doping concentrations of electrons and holes, respectively. If we want to obtain the maximum photo-response, Eq. (2.5) represents how to decide the values of the parameters. That is to say, the width of WU should be as near the width of the depletion region as possible, the width of WD should be as large as possible, and for the doping concentration it should be as low as possible to design a photodiode. If the design criterion is followed, the maximum photo-response would be acquired.

$$R = f(WU, WD, n, p)_{V=0} \dots\dots\dots(2.4)$$

$$R_{Max} = f(WU \rightarrow Depletion, WD \rightarrow Max, n \rightarrow Min, p \rightarrow Min)_{V=0} \dots\dots(2.5)$$

[0069] If the detailed mathematical equations are explored based on the photodiode in Fig. 4, then the photo currents could be interpreted by the following three equations:

$$\frac{q \phi_0 \alpha e^{-\alpha W} L_p \left(L_p (\alpha D_p - S_p) \cosh \left[\frac{TN}{L_p} \right] + (D_p + \alpha L_p^2 S_p) \sinh \left[\frac{TN}{L_p} \right] + e^{\alpha W} L_p (\alpha D_p + S_p) \right)}{(1 + \alpha^2 L_p^2) \left(D_p \cosh \left[\frac{TN}{L_p} \right] + L_p S_p \sinh \left[\frac{TN}{L_p} \right] \right)} \dots\dots\dots(2.6)$$

$$\frac{q \phi_0 \alpha e^{-(\alpha W + \alpha D_p + \alpha D_n)} D_n \left(e^{\alpha W} L_n \left(L_n (\alpha D_n - S_n) \cosh \left[\frac{TP}{L_n} \right] + (-D_n + \alpha L_n^2 S_n) \sinh \left[\frac{TP}{L_n} \right] \right) - e^{\alpha W} L_n (\alpha L_n^2 - S_n \tau_n) \right)}{L_n (-1 + \alpha^2 L_n^2) \left(D_n \cosh \left[\frac{TP}{L_n} \right] + L_n S_n \sinh \left[\frac{TP}{L_n} \right] \right)} \dots\dots\dots(2.7)$$

$$q \phi_0 \left(e^{-\alpha (DRN + WN)} - e^{-\alpha (DRP + WN)} \right) \dots\dots\dots(2.8)$$

[0070] Eq. (2.6) represents the photo-current induced from the N-typed region, Eq. (2.7) represents the photo-current induced from the P-typed region, and Eq. (2.8) represents the current in the depletion region where L_p and L_n represents the diffusion lengths of holes in the N-typed region and electrons in the P-typed region, respectively, of which values could be acquired by taking the square root of the product of the diffusion coefficient of the electrons (holes) and their mean lifetime. T_N represents the width of the N-typed region (W_N) minus the width of the depletion region in the N-typed region (DR_N) whereas T_P represents the width of the P-typed region (W_P) minus the width of the depletion region in the P-typed region (DR_P).

[0071] From Eq. (2.6), ~~it could find~~ the impact of the widths of the depletion region and the lighted semiconductor ~~toward~~ with respect to the photo-response are found. When the width of the depletion region is ~~close~~ equal to the thickness of the lighted semiconductor, the maximum value of the photo-response ~~could~~ can be obtained by using the ~~adequate doping concentration~~ lowest concentration in the scope of the fabrication technique, which could be understood from the relationship between the diffusion length and the absorption length. If it is represented by the a

mathematical equation, the relationship is illustrated by the following mathematical expression and analysis.

[0072] First ~~make the differential operation toward~~ differentiate the Eq. (2.4) with respect to the variable TN ~~of the photo-response by using TN~~, and then two maximum values would occur when TN equals 0 or α equals L_p . On the other hand, if we perform the differential operation toward TP, the equation of the photo-response become a positive formula. That is to say, the photo-response increases with TP. ~~While~~ When TP is not considered, two conditions can be applied to ~~make~~ reach the conclusion on the design method regarding to the single PN junction:

- (1) $TN=0$ (i.e., $WN=DRN$, and
- (2) $\alpha=L_p$.

[0073] The above first condition could be used in the equation of the photo-response to derive the following equation.

$$WN = \sqrt{\frac{2\varepsilon_{si}(\phi_{vt} + V_{bias})}{q} \left(\frac{1}{n} + \frac{1}{p} \right)} \times \frac{p}{n+p} \dots\dots\dots(2.9)$$

[0074] The second condition could be utilized in the equation of the photo-response to derive Eq. (2.10) with understanding the relationship between the doping concentration and the maximum photo-response under a certain

wavelength. Since α is the α function of wavelengths, and L_p is the α function of concentration, the new function of Eq. (2.10) is thus obtained, which is the relationship between wavelengths and concentration, to be the design criterion.

$$10^{(13.2131 - 36.7985\lambda + 48.1893\lambda^2 - 22.7562\lambda^3)} = \sqrt{1.083 \times 10^{18} \times \frac{6.992 \times 10^{17}}{n + 2.990 \times 10^{17}}} \times \sqrt{8.527 \times 10^{10} \times \frac{2.9 \times 10^{19}}{n + 1.999 \times 10^{18}}} \quad (2.10)$$

In the following, we should discuss about the method of obtaining the peak photo-response at a specific wavelength. First, equations of Eqs. (2.6), (2.7) and (2.8) are summed up, and then the photo-current equation of the photo-response is obtained. Next take out the parameters of α and ϕ_0 , and replace them with the functions of wavelengths where α could be replaced by Eq. (2.3) and ϕ_0 could be replaced by Eq. (2.1). Next the other parameters should be replaced with the functions of concentration by utilizing Eqs. (2.9) and (2.10). After two replacements, the photo-current equation could be interpreted as a function of wavelength and concentration. Now it is assumed that the peak value of the photo-response appears at λ_1 . The differential operation toward with respect to λ is performed in Eq. (2.11) to obtain Eq. (2.12); next, λ is replaced by λ_1 in Eq. (2.13), and then the differential equation is solved to make itself equal to zero. The whole process could be illustrated in the following three equations.

$$R = f(\lambda, n, p, V) \dots\dots\dots (2.11)$$

$$\frac{\partial R}{\partial \lambda} = f'(\lambda, n, p, V) \dots\dots\dots (2.12)$$

$$f'(\lambda, n, p, V)_{\lambda=\lambda_1} = 0 \dots\dots\dots (2.13)$$

[0075] As mentioned above by utilizing Eqs. (2.11), (2.12) and (2.13), the values of the process parameters for yielding the peak photo-response can thus be adequately determined.

3. Design method of the photodiodes without color filters

[0076] The number of PN junctions formed by the material layers from the commercial process is very small. Fig. 18 shows the material layers of the TSMC two processes for designing photodiodes. From such figure, the structure with two PN junctions is the P+_Nwell_Psubstrate photodiode. The layers of the PN junction with different thickness generate different photo-response. Hence, this invention proposes the photodiode with multiple PN junctions as shown in Fig. 19 to provide multiple sets of photo-responses for selection.

[0077] Next we consider the way of how to separate and take out one from multiple sets of the photo-response. The basic principle of this invention could be illustrated first from the Pdiffusion-Nwell-Psubstrate structure using the TSMC 1P3M 0.6um CMOS process, as shown in Fig. 20, with two PN junctions which are

Pdiffusion-Nwell and Nwell-Psubstrate. The photodiode with this Pdiffusion-Nwell-Psubstrate structure could provide two sets of photo-responses. The total photo-response of the photodiode is the sum of the photo-currents contributed by these two PN. The photodiode with different depths of the PN junctions and different concentrations of the ion doping in each layer yields different photo-responses. Fig. 21 is the simulation result by utilizing the Pdiffusion-Nwell-Psubstrate photodiode. From that simulation result, it ~~could~~ can be seen that the photodiode has two sets of photo-responses due to its two PN junctions. Now if we want to take out one of these two sets of photo-responses, the scheme we use is to short the PN junction that we do not want. Fig. 22 shows the photodiode with shorting a PN junction. Once the PN junction is to be shorted, the electron-hole pairs generated within this PN junction are recombined, and thereby the photo-current contributed by such junction would be erased. That is to say, if we short Pdiffusiion and Nwell layers, the photo-response having a peak value at a short wavelength of such layers would be disappear. On the contrary, if we short the Nwell and Psubstrate layers, the photo-response having a peak value at a long wavelength would be erased where the photodiode just has only the photo-response of the Pdiffusion-Nwell junction.

[0078] Utilizing such kind of idea, the following structure is proposed to design

the photodiode ~~with yielding~~ that yields multiple photo-responses. As shown in Fig. 23, if the process could provide multiple PN junctions with various depths, each junction has a different photo-response. Next we design switches which could short PN junctions. Utilizing each switch to determine the usage of each PN junction or not, this invention could thus efficiently obtain the required photo-response ~~under~~ with adaptive control. Fig. 24 shows the simulation result of the photodiode with three PN junctions.

[0079] According to the analysis results of the previous paragraphs, it could be found that if we try to efficiently obtain the different photo-responses in a photodiode, we could achieve them by altering the amount of the induced currents from the N-type semiconductor, the depletion region and P-typed semiconductor. ~~To achieve such purpose, someone proposed to utilize the way of~~ This result is achieved by controlling the reverse bias voltage, of which basic principle is to alter the width of the depletion region by using the reverse bias voltage. Once the width of the depletion region is altered, the boundary values of the N-typed and P-typed semiconductors are altered also, which influence the overall photo-response to achieve the purpose of shifting the peak value of the photo-response. However, as for the practical implementation which could be seen from the simulation result as

shown in Fig. 25, when the reverse bias voltage is between 0 and 5V, the overall photo-response is almost unaltered at different reverse bias voltages. The reason can be observed from Fig. 26. When the reverse bias voltage is changed from 0V to 5V, the change in the depletion region is less than 1 μm , which ~~makes~~ causes the overall photo-response to be dominated by the induced current from the P-typed semiconductor. As shown in Fig. 27, the measurement result of the Nwell-Epi-Psubstrate photodiode illustrates that the effect of utilizing the reverse bias voltage to control the photo-response is not obvious.

1. Explanation of the preferred embodiment:

[0080] Fig. 28 shows the overall photo-response by using the signal summation of the two photodiodes with different photo-responses under various areas. We can find that under a specific condition of the area ratio, a set of photo-response with the ~~most smooth~~ smoothest curve can be achieved. The experiments ~~discovered~~ from Figs. 28(a), 28(b) and 28(c) demonstrate the practicability of linear summation, as is revealed in Figs. 28(a), 28(b) and 28(c). This invention adds the signals of several photodiodes with different photo-responses and with different photo-sensitive areas to acquire the demanded photo-response.

[0081] Fig. 29 is the measured result of the Pdiffusion-Nwell-Psubstrate

photodiode fabricated by the TSMC. The peak value of the photo-response is moved to the position at a short wavelength when the Nwell and Psubstrate are shorted, or connected together through the conducting metal. On the other hand, when the Pdiffusion and Nwell are shorted together, the peak value of the photo-response is moved to the position at a long wavelength. From such figure we could see clearly that, in the same photodiode, the peak value of the photo-response can be shifted by shorting some semiconductor layers. Besides, we make simulations utilizing the photodiode with three PN junctions, of which concentration and thickness in each layer are depicted in Fig. 30. In chip layout, let's take switches using the CMOS transistors to short three different junctions, as shown in Fig. 31, so that we could obtain red, green and blue photo-responses in a single photodiode. Fig. 32 is the simulation result of this photodiode with three PN junctions.

[0082] The photodiode with multiple PN junctions is designed to sense multiple colors by shorting some PN junctions. In other words, the photodiode with adaptive PN junctions can select the peak value of the photo-response at a specific wavelength. Utilizing such an approach, we ~~could~~ can fabricate the a photodiode ~~with sensing that senses~~ multiple colors without using color filters when the adequate appropriate values of the process parameters are used.

Characteristics and effects:

[0083] The design methods and apparatuses of photodiodes with adaptive structures to achieve smooth and wavelength-selective photo-responses provided by this invention have the following advantages in comparison of with the other conventional methods and devices.

1. This invention utilizes ~~the~~ photodiodes with different photo-responses and different photo-sensing areas or connects the photodiodes to the back-end amplifiers with different gains. Next, linear addition is performed toward the photo-responses from these photodiodes, and then a ~~set of~~ curve set with a large value at each wavelength is obtained, which is also smooth. The object of this invention is to improve the non-uniform distribution of the photo-response of the photodiode in wavelengths of visible light. In addition, it also aids to ~~simply~~ simplify the design of the back-end color compensation circuits.
2. This invention concludes some schemes of determining the values of the process parameters. These schemes can help to make a good use of physical characteristics of the photodiode in order to increase the photo-response of the photodiode and to yield the peak value of the photo-

response of the photodiode and to yield the peak value of the photo-response at a specific wavelength.

3. This invention explores the feasibility of ~~the~~ color photodiodes without the use of color filters and provides a layout scheme to adapt the photo-response of the photodiode. Since the PN junctions with different depths generates the photo-responses with peak values at different wavelengths, by utilizing such principles, the photodiode with multiple PN junctions can have multiple photo-responses. Next, we make switches in a photodiode to select a specific photo-response and thus this photodiode can adaptively sense different colors.

[0084] Many changes and modifications in the above described embodiment of the invention can, of course, be carried out without departing from the scope thereof. Accordingly, to promote the progress in science and the useful arts, the invention is disclosed and intended to be limited only by the scope of the appended claims.